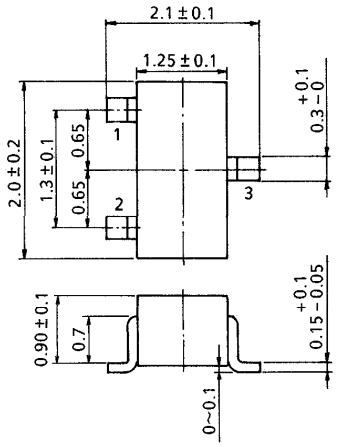
TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE

SSM3K05FU

HIGH SPEED SWITCHING APPLICATIONS

Unit in mm

- Small Package
- Low on Resistance : R_{on} = 0.8 Ω Max. (@V_{GS} = 4 V)
  : R_{on} = 1.2 Ω Max. (@V_{GS} = 2.5 V)
- Low Gate Threshold Voltage



1 : GATE
2 : SOURCE
3 : DRAIN

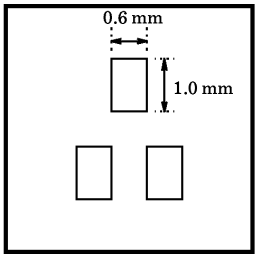
USM	
JEDEC	—
EIAJ	SC-70
TOSHIBA	2-2E1E

Weight : 0.006 g (Typ.)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DS}	20	V
Gate-Source Voltage		V_{GSS}	±12	V
Drain Current	DC	I_D	400	mA
	Pulse	I_{DP}	800	
Drain Power Dissipation (Ta = 25°C)		P_D*	150	mW
Channel Temperature		T_{ch}	150	°C
Storage Temperature Range		T_{stg}	−55~150	°C

* Mounted on FR4 board.
(25.4 mm × 25.4 mm × 1.6 t, Cu Pad : 0.6 mm^2 × 3)



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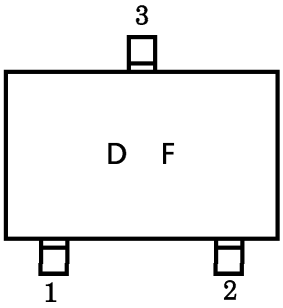
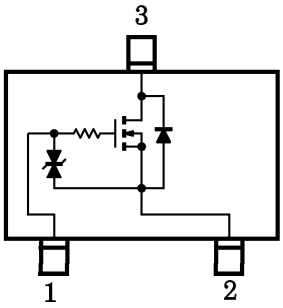
MARKING



EQUIVALENT CIRCUIT (TOP VIEW)



HANDLING PRECAUTION

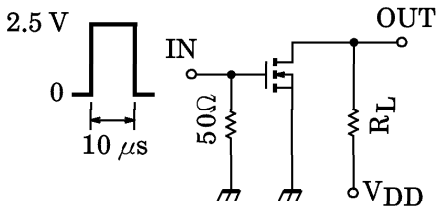
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

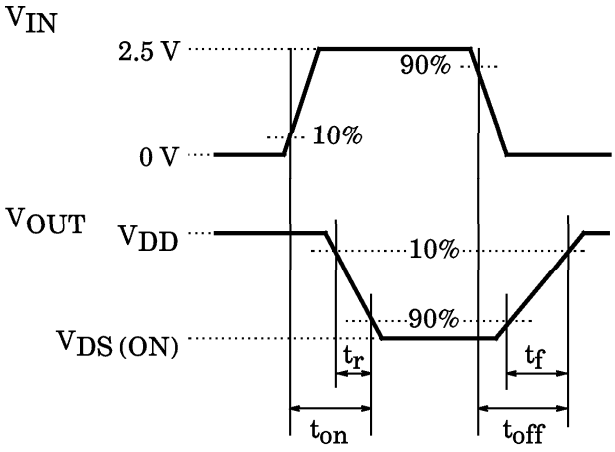
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	V_{GS} = ±12 V, V_{DS} = 0	—	—	±1	μA
Drain-Source Breakdown Voltage		$V_{(BR)\,DSS}$	I_D = 1 mA, V_{GS} = 0	20	—	—	V
Drain Cut-off Current		I_{DSS}	V_{DS} = 20 V, V_{GS} = 0	—	—	1	μA
Gate Threshold Voltage		V_{th}	V_{DS} = 3 V, ID = 0.1 mA	0.6	—	1.1	V
Forward Transfer Admittance		$\|Y_{fs}\|$	V_{DS} = 3 V, I_D = 200 mA (Note)	350	—	—	mS
Drain-Source ON Resistance		$R_{DS\,(ON)}$	I_D = 200 mA, V_{GS} = 4 V (Note)	—	0.6	0.8	Ω
			I_D = 200 mA, V_{GS} = 2.5 V (Note)	—	0.85	1.2	
Input Capacitance		C_{iss}	V_{DS} = 3 V, V_{GS} = 0, f = 1 MHz	—	22	—	pF
Reverse Transfer Capacitance		C_{rss}	V_{DS} = 3 V, V_{GS} = 0, f = 1 MHz	—	9	—	pF
Output Capacitance		C_{oss}	V_{DS} = 3 V, V_{GS} = 0, f = 1 MHz	—	21	—	pF
Switching Time	Turn-on Time	t_{on}	V_{DD} = 3 V, I_D = 100 mA, V_{GS} = 0~2.5 V	—	60	—	ns
	Turn-off Time	t_{off}		—	70	—	

(Note) : Pulse test

SWITCHING TIME TEST CIRCUIT



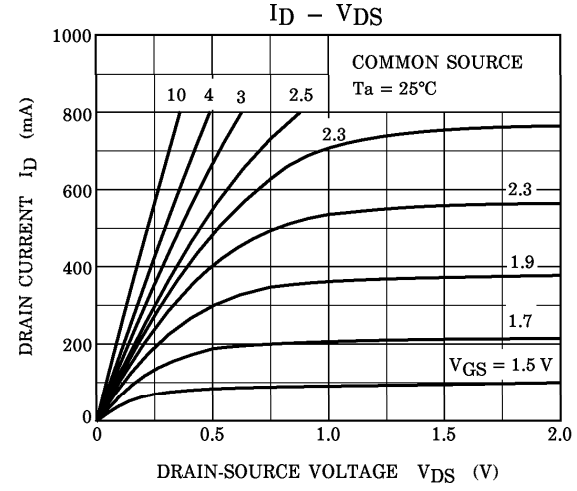


V_{DD} = 3 V
D.U. ≦ 1%
V_{IN} : t_r, t_f < 5 ns
(Z_{OUT} = 50 Ω)
COMMON SOURCE
Ta = 25°C

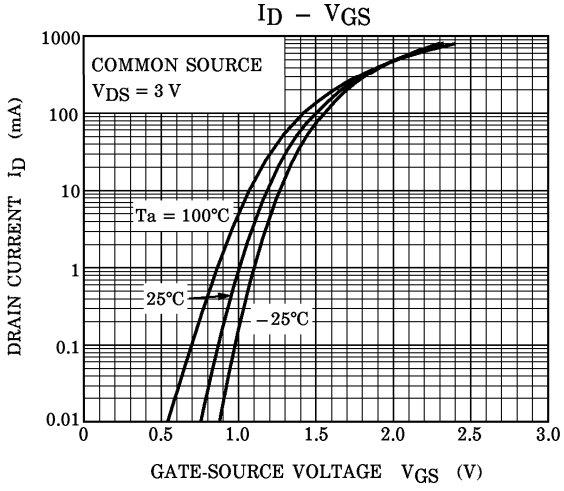
PRECAUTION

V_{th} can be expressed as voltage between gate and source when low operating current value is I_D = 100 μA for this product. For normal switching operation, $V_{GS\,(on)}$ requires higher voltage than V_{th} and $V_{GS\,(off)}$ requires lower voltage than V_{th}.
(Relationship can be established as follows : $V_{GS\,(off)} < V_{th} < V_{GS\,(on)}$)
Please take this into consideration for using the device.
V_{GS} recommended voltage of 2.5 V or higher to turn on this product.

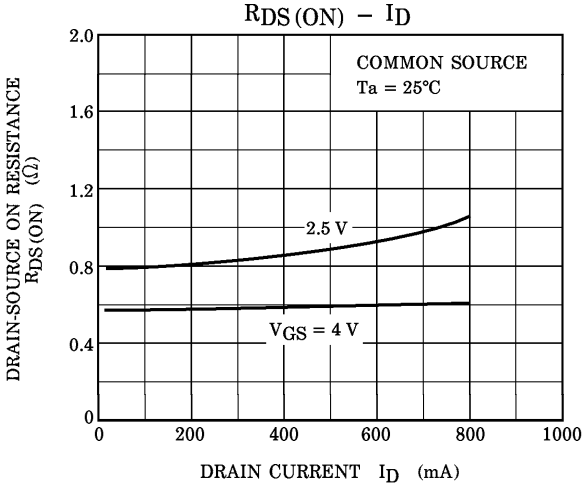
$I_D - V_{DS}$



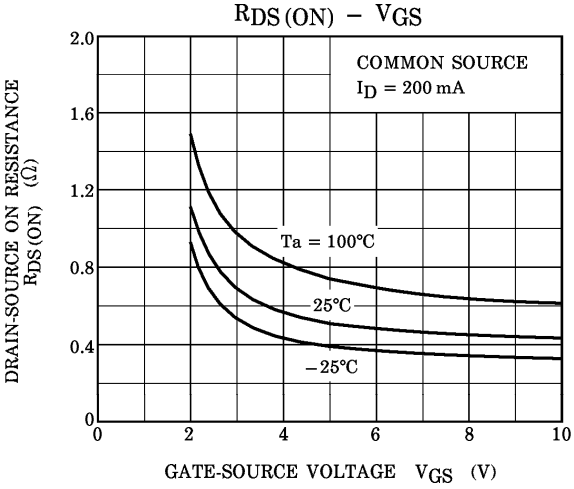
$I_D - V_{GS}$



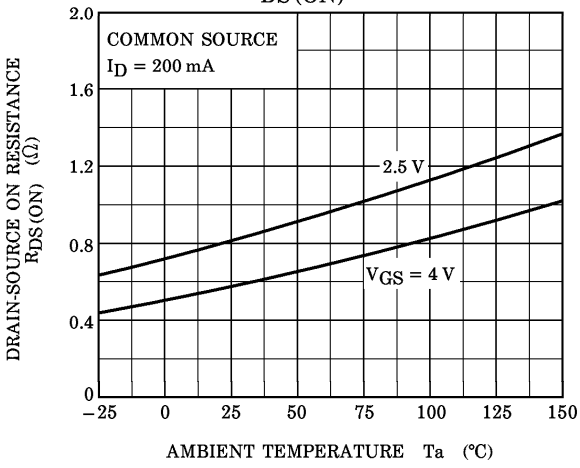
$R_{DS\,(ON)} - I_D$



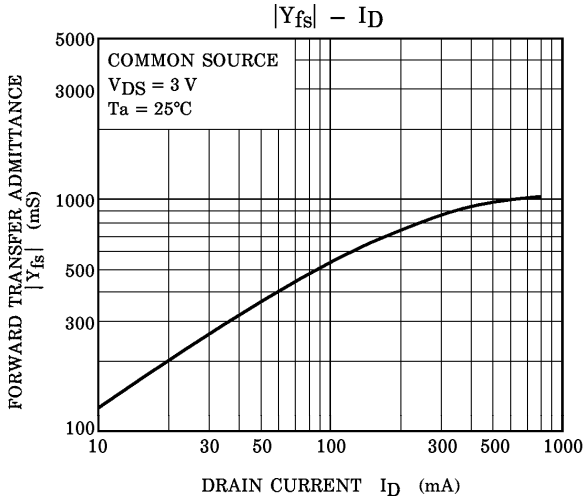
$R_{DS\,(ON)} - V_{GS}$



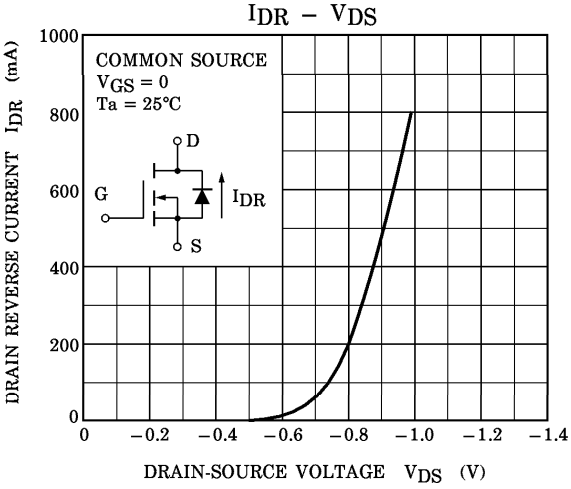
$R_{DS\,(ON)} - Ta$



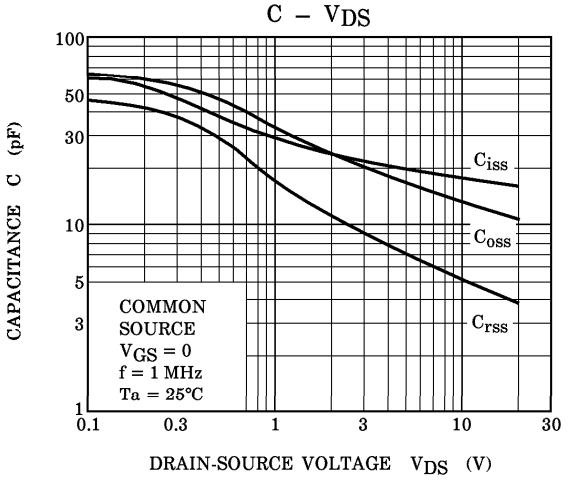
$|Y_{fs}| - I_D$



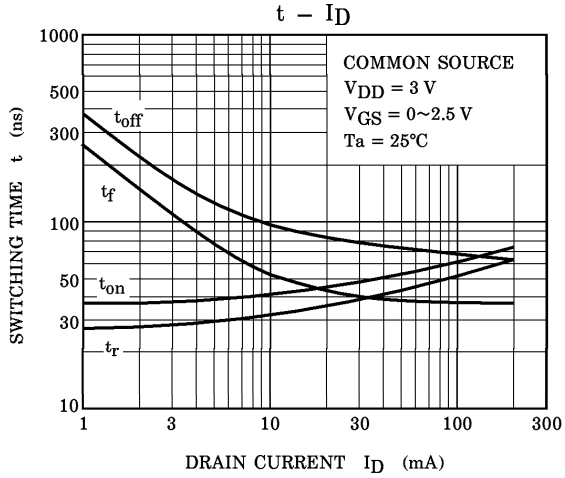
I_{DR} – V_{DS}



C – V_{DS}



t – I_D



P_D – Ta